

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L3	1	("6727583").PN.	USPAT	OR	OFF	2005/07/25 10:04
S1	1	("20020060084").PN.	US-PGPUB; USPAT	OR	OFF	2005/07/19 15:55
S2	1	("20020117762").PN.	US-PGPUB; USPAT	OR	OFF	2005/07/19 15:55
S3	1	("20030082852").PN.	US-PGPUB; USPAT	OR	OFF	2005/07/19 15:55
S4	1	("5218234").PN.	US-PGPUB; USPAT	OR	OFF	2005/07/19 15:55
S5	1	("5789820").PN.	US-PGPUB; USPAT	OR	OFF	2005/07/19 15:55
S6	1	("5817545").PN.	US-PGPUB; USPAT	OR	OFF	2005/07/19 15:55
S7	1	("5874783").PN.	US-PGPUB; USPAT	OR	OFF	2005/07/19 15:56
S8	7	S1 S2 S3 S4 S5 S6 S7	US-PGPUB; USPAT	OR	OFF	2005/07/19 15:57
S9	2529	257/678.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 11:20
S10	5627	(semiconductor or ic or die or chip or (integrated adj circuit)) and (underfill or under adj fill)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/19 15:59
S11	5627	(semiconductor or ic or die or chip or (integrated adj circuit)) and (underfill or (under adj fill))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/19 15:59
S12	2220	S11 and "257"/\$6.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/19 16:00
S13	2218	S11 and "257"/\$6.ccls.	US-PGPUB; USPAT	OR	OFF	2005/07/19 16:00
S14	1062	S11 and "257"/\$6.ccls.	US-PGPUB	OR	OFF	2005/07/20 10:24
S15	1156	S11 and "257"/\$6.ccls.	USPAT	OR	OFF	2005/07/19 16:00

S16	5627	(semiconductor or ic or die or chip or (integrated adj circuit)) and (underfill or (under adj fill))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 10:24
S17	1064	S16 and "257"/\$6.ccls.	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 10:37
S18	1	("6919226").PN.	USPAT	OR	OFF	2005/07/20 10:37
S19	1	"6365438".PN.	USPAT; USOCR	OR	OFF	2005/07/20 10:38
S20	1	"6184143".PN.	USPAT; USOCR	OR	OFF	2005/07/20 10:38
S21	1	"6110806".PN.	USPAT; USOCR	OR	OFF	2005/07/20 10:39
S22	1	"5151388".PN.	USPAT; USOCR	OR	OFF	2005/07/20 10:39
S23	571	257/685.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 11:20
S24	467	257/688.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 11:21
S25	2177	257/723.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 13:27
S26	1947	257/737.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 11:21
S27	1682	257/738.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 11:21

S28	2509	257/778.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 11:21
S29	1061	257/779.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 11:21
S30	751	257/782.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:38
S31	1034	257/783.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:56
S32	423	257/789.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:08
S33	302	257/795.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:03
S34	2115	S30 S31 S32 S33	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:56
S35	3119	S34 S17	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:56
S36	1156	S16 and "257"/\$6.ccls.	USPAT	OR	OFF	2005/07/20 12:57

S37	176	S35 and S36	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:57
S38	4099	S35 or S36	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:57
S39	7009	S25 S26 S27 S28 S29	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:59
S40	5641	S39 not S38	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:58
S41	3410	S39 not S38	USPAT	OR	OFF	2005/07/20 12:58
S42	5181	S26 S27 S28 S29	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:59
S43	3936	S42 not S38	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 12:59
S44	825	S42 not S38	US-PGPUB	OR	OFF	2005/07/20 12:59
S45	345	257/723.ccls.	US-PGPUB	OR	OFF	2005/07/20 13:53
S46	1832	257/723.ccls.	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:29
S47	5627	(semiconductor or ic or die or chip or (integrated adj circuit)) and (underfill or (under adj fill))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:30

S48	1064	S47 and "257"/\$6.ccls.	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:30
S49	751	257/782.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:30
S50	1034	257/783.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:30
S51	423	257/789.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:30
S52	302	257/795.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:30
S53	2115	S49 S50 S51 S52	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:30
S54	3119	S53 S48	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:30
S55	1156	S47 and "257"/\$6.ccls.	USPAT	OR	OFF	2005/07/20 15:30
S56	4099	S54 or S55	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:30

S57	1832	257/723.ccls.	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:30
S58	4457	S56 S57	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:32
S59	345	257/723.ccls.	US-PGPUB	OR	OFF	2005/07/20 15:31
S60	4457	S58 S59	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:31
S61	5769	S56 S57	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:32
S62	6061	S61 S59	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:32
S63	571	257/685.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:34
S64	467	257/688.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:34
S65	1947	257/737.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:34
S66	1682	257/738.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:34

S67	2509	257/778.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 16:25
S68	1061	257/779.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:34
S69	6059	S63 S64 S65 S66 S67 S68	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:34
S70	4316	S69 not S62	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 15:34
S71	2532	S69 not S62	USPAT	OR	OFF	2005/07/20 16:02
S72	1784	S69 not S62	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 16:02
S73	916	S71 and die	USPAT	OR	OFF	2005/07/20 16:03
S74	1616	S71 not S73	USPAT	OR	OFF	2005/07/20 16:27
S75	1315	438/108.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 16:26
S76	2077	438/614.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 16:26
S77	3323	S75 S76	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 16:26

S78	2741	S77 not S69	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 16:26
S79	2647	S78 not S62	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 16:26
S80	2647	S79 not S70	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/20 16:27